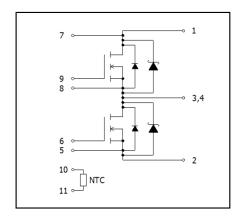
### Application

- · Motor drive
- · Inverter, Converter
- · Photovoltaics, wind power generation.
- · Induction heating equipment.

#### Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

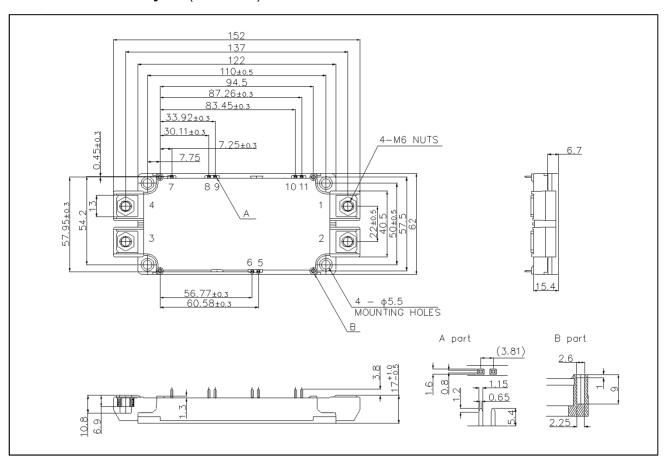
#### ●Circuit diagram



#### Construction

This product is a half bridge module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

#### ●Dimensions & Pin layout (Unit: mm)

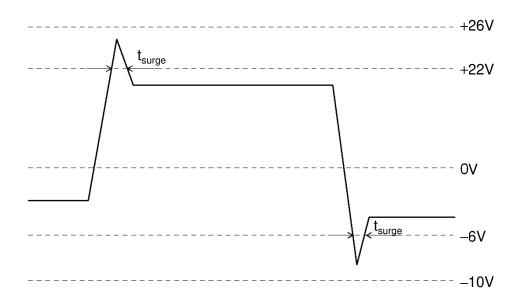


# ●Absolute maximum ratings (T<sub>i</sub> = 25°C)

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	$V_{DSS}$	G-S short 1200			
Gate-source voltage(+)	$V_{GSS}$	D-S short	22	V	
Gate-source voltage(-)	V GSS	D-3 SHOIL	-6		
G - S Voltage (t <sub>surge</sub> <300nsec)	$V_{GSS\_surge}$	D-S short	-10 to 26		
Drain current *1	$I_D$	DC (T <sub>c</sub> =60°C)	204		
	I <sub>DRM</sub>	Pulse (T <sub>c</sub> =60°C) 1ms *2	360	- A	
	I <sub>DRM</sub>	Pulse (T <sub>c</sub> =60°C) 10us *2	540		
Source current *1	I <sub>S</sub>	DC ( $T_c$ =60°C ) $V_{GS}$ =18V	204		
	I <sub>SRM</sub>	Pulse (Tc=60°C) 1ms V <sub>GS</sub> =18V *2	360		
	I <sub>SRM</sub>	Pulse (Tc=60°C) 10us V <sub>GS</sub> =18V *2	540		
Total power disspation *3	Ptot	T <sub>c</sub> =25°C	1360	W	
Max Junction Temperature	$T_{jmax}$		175		
Operating junction temperature			-40 to150	°C	
Storage temperature	$T_{stg}$		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque		Main Terminals : M6 screw	4.5	N · m	
		Mounting to heat shink: M5 screw	3.5		

<sup>(\*1)</sup> Case temperature (T<sub>c</sub>) is defined on the surface of base plate just under the chips.

# Example of acceptable $V_{\text{GS}}$ waveform



<sup>(\*2)</sup> Repetition rate should be kept within the range where temperature rise if die should not exceed  $T_{j\,max}$ .

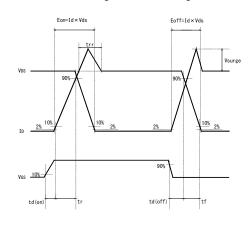
<sup>(\*3)</sup> T<sub>i</sub> is less than 175°C

## ●Electrical characteristics (T<sub>i</sub>=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Static drain-source on-state voltage	V <sub>DS(on)</sub>	I <sub>D</sub> 180A, V <sub>GS</sub> =18V	T <sub>j</sub> =25°C	-	2.2	3.2	V
			T <sub>j</sub> =125°C	-	3.1	-	
			T <sub>j</sub> =150°C	-	3.5	5.0	
Drain cutoff current	$I_{DSS}$	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V	-	-	3.2	mA	
Source-drain voltage	$V_{SD}$	V <sub>GS</sub> =0V, I <sub>S</sub> =180A	T <sub>j</sub> =25°C	-	1.6	2.2	V
			T <sub>j</sub> =125°C		2	-	
			T <sub>j</sub> =150°C	-	2.2	3.3	
		V <sub>GS</sub> =18V, I <sub>S</sub> =180A	T <sub>j</sub> =25°C	-	1.3	-	
			T <sub>j</sub> =125°C		1.5	-	
			T <sub>j</sub> =150°C	-	1.6	-	
Gate-source threshold voltage	$V_{GS(th)}$	V <sub>DS</sub> =10V, I <sub>D</sub> =35.2mA		1.6	-	4	V
Gate-source leakage current	I <sub>GSS</sub>	$V_{GS}$ =22V, $V_{DS}$ =0V		1	-	0.5	μΑ
		$V_{GS} = -6V, V_{DS} = 0V$		-0.5	-	-	
Switching characteristics	t <sub>d(on)</sub>	$V_{GS(on)}=18V, V_{GS(off)}=0V$		-	45	-	ns
	t <sub>r</sub>	V <sub>DS</sub> =600V		-	45	-	
	t <sub>rr</sub>	I <sub>D</sub> =180A	-	45	-		
	t <sub>d(off)</sub>	$R_{G(on)}$ =1.0 $\Omega$ , $R_{G}$ =0.2 $\Omega$ inductive load		-	125	-	
	t <sub>f</sub>			-	45	-	
Input capacitance	Ciss	$V_{DS} = 10V, V_{GS} = 0V, 200$	1	18	-	nF	
Gate Registance	$R_{Gint}$	T <sub>j</sub> =25°C	-	1.2	-	Ω	
NTC Rated Resistance	R25			5.0		kΩ	
NTC B Value	B50/25			3370		K	
Stray Inductance	Ls				13.0	-	nΗ
Creepage Distance	-	Terminal to heat sink			14.5	-	mm
		Terminal to terminal			15.0	-	mm
Clearance Distance	-	Terminal to heat sink			12.0	-	mm
		Terminal to terminal			9.0	-	mm
Junction-to-case thermal resistance	R <sub>th</sub> (j-c)	DMOS (1/2 module) *4		-	-	0.11	°C/W
		SBD (1/2 module) *4		-	-	0.14	
Case-to-heat sink	R <sub>th</sub> (c-f)	Case to heat sink, per 1 module,			0.035	-	
Thermal resistance	i ith(C-I)	Thermal grease applie	oplied * <sup>5</sup>				

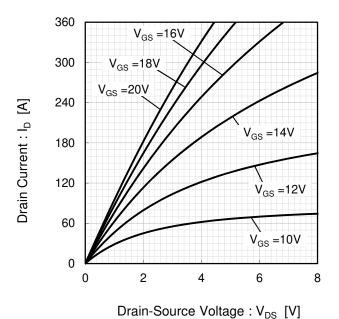
- (\*4) Measurement of Tc is to be done at the point just under the chip.
- (\*5) Typical value is measured by using thermally conductive grease of  $\lambda$ =0.9W/(m K).
- (\*6) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>



#### • Electrical characteristic curves (Typical)

Fig.1 Typical Output Characteristics [  $T_i$ =25 $^{\circ}$ C ] Fig.2 Drain-Source Voltage vs. Drain Current



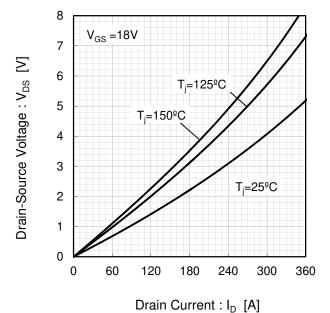
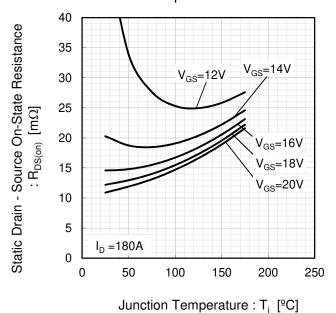


Fig.3 Drain-Source Voltage vs. Gate-Source Voltage [T<sub>i</sub>=25°C] 5 T<sub>i</sub>=25°C Drain-Source Voltage: V<sub>DS</sub> [V] 4 3  $I_{D} = 180A$ 2 I<sub>D</sub>=120A  $I_D=90A$ 1  $I_D = 60A$ 0 12 14 16 18 20 22 24

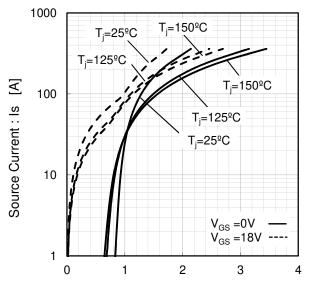
Gate-Source Voltage : V<sub>GS</sub> [V]

Fig.4 Static Drain - Source On-State Resistance vs. Junction Temperature



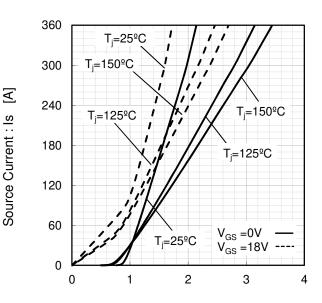
#### ●Electrical characteristic curves (Typical)

Fig.5 Forward characteristic of Diode



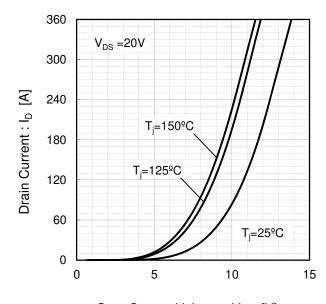
Source-Drain Voltage :  $V_{SD}$  [V]

Fig.6 Forward characteristic of Diode



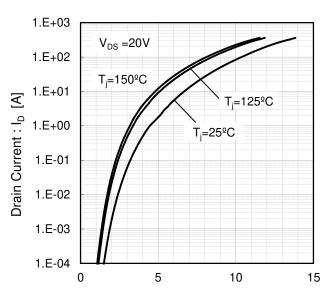
Source-Drain Voltage: V<sub>SD</sub> [V]

Fig.7 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage :  $V_{GS}$  [V]

Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage: V<sub>GS</sub> [V]

#### • Electrical characteristic curves (Typical)

Fig.9 Switching Characteristics [T<sub>i</sub>=25°C]

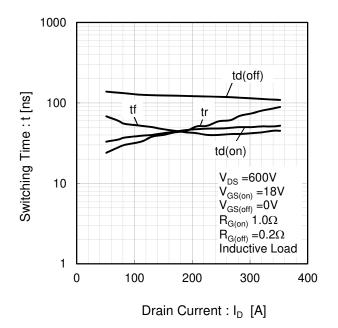


Fig.10 Switching Characteristics [T<sub>i</sub>=125°C]

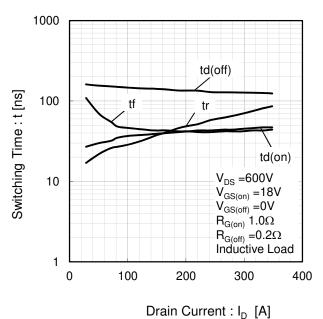


Fig.11 Switching Characteristics [T<sub>i</sub>=150°C]

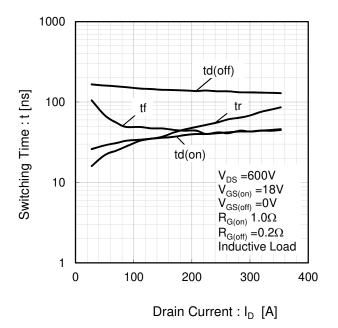
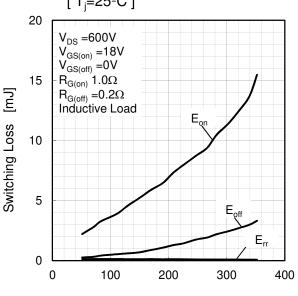


Fig.12 Switching Loss vs. Drain Current [ $T_i=25^{\circ}C$ ]



Drain Current : I<sub>D</sub> [A]

#### ●Electrical characteristic curves (Typical)

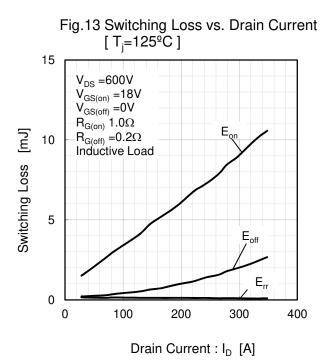
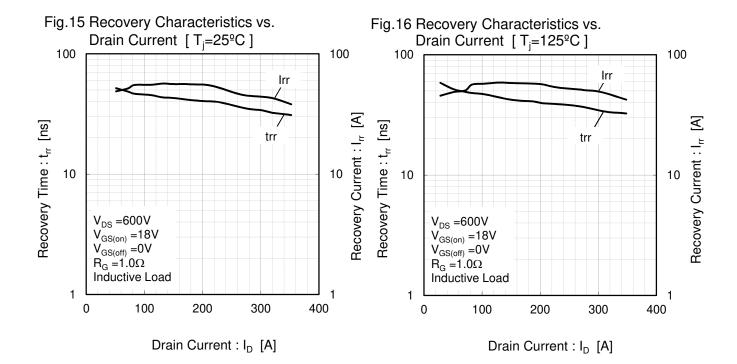


Fig.14 Switching Loss vs. Drain Current  $[T_i=150^{\circ}C]$ 15  $V_{DS} = 600V$  $V_{GS(on)} = 18V$  $V_{GS(off)} = 0V$  $R_{G(on)} = 1.0\Omega$  $R_{G(off)} = 0.2\Omega$ 10 Inductive Load 5  $E_{rr}$ 0 0 100 200 300 400

Drain Current: I<sub>D</sub> [A]



Switching Loss [mJ]

#### ●Electrical characteristic curves (Typical)

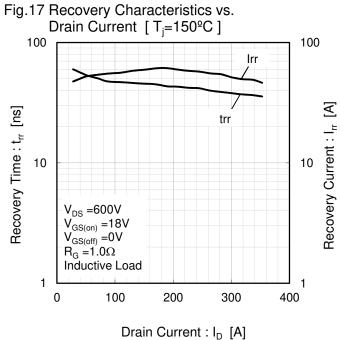
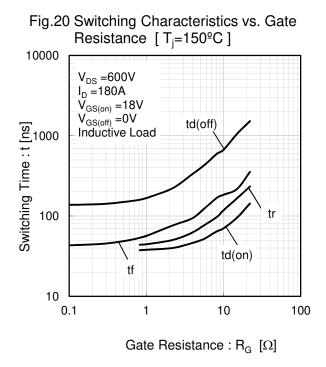


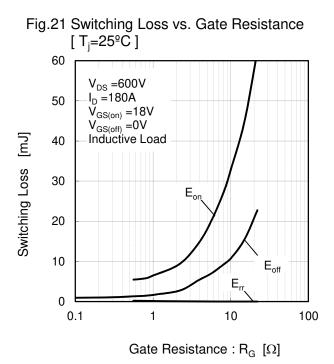
Fig. 18 Switching Characteristics vs. Gate Resistance [ $T_j=25^{\circ}C$ ]  $V_{DS} = 600V$   $I_{D} = 180A$   $V_{GS(on)} = 18V$   $V_{GS(off)} = 0V$ Inductive Load td(off) tr 10 0.1 1 1 10 100

Gate Resistance :  $R_G$  [ $\Omega$ ]

Fig. 19 Switching Characteristics vs. Gate Resistance [ $T_j$ =125 $^{\circ}$ C]  $V_{DS}$  =600 $V_{D_D}$  =180 $V_{DS}$  =180 $V_{DS}$  =180 $V_{DS}$  | Inductive Load | Ind



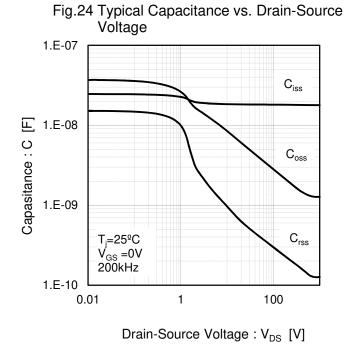
#### • Electrical characteristic curves (Typical)



Gate Resistance :  $R_G$  [ $\Omega$ ]

Switching Loss [mJ]

Fig.23 Switching Loss vs. Gate Resistance  $[T_i=150^{\circ}C]$ 60 V<sub>DS</sub> =600V 50  $I_{D} = 180A$  $V_{GS(on)} = 18V$   $V_{GS(off)} = 0V$ Inductive Load Switching Loss [mJ] 40 E, 30 20  $\mathsf{E}_{\mathsf{off}}$ 10 0 0.1 10 100 Gate Resistance :  $R_G$  [ $\Omega$ ]



## ● Electrical characteristic curves (Typical)

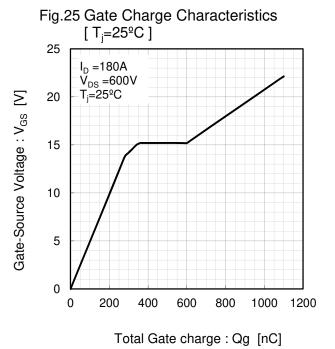


Fig.26 Normalized Transient Thermal Impedance 1 Single Pulse  $T_c=25^{\circ}C$  Per unit base DMOS part : 0.11K/W SBD part : 0.14K/W SBD part : 0.14K/W Time [s]

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